General Description

The SJP4435 uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as -4.5V. This device is suitable for use as a wide variety of applications.

Features

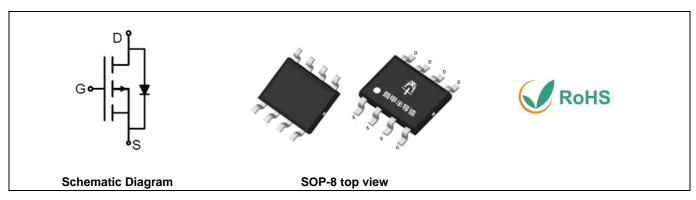
- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

Application

- PWM Applications
- Load Switch
- Power Management

Key Performance Parametes

Parameter	Value	Unit
V _{DS}	-30	V
R _{DS(ON)_TYP}	17	mΩ
ID	-9.5	А
Q _G	59	nC



Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJP4435	SJP4435	SOP-8	Tape	\	\	4000 Pcs

Table 1. Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V _{DS}	Drain-Source Voltage (V _{GS} =0V)	-30	V
Vgs	Gate-Source Voltage (V _{DS} =0V)	±20	V
1-	Drain Current-Continuous(T _A =25°C)	-9.5	А
I _D	Drain Current-Continuous(T _A =100°C)	-6	А
I _{DM} (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	-38	А
D	Maximum Power Dissipation(T _A =25°C)	3	W
P _D	Maximum Power Dissipation(T _A =100°C)	1.2	W
Eas	Avalanche energy (Note 2)	56	mJ
TJ, TSTG	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
$R_{ heta JA}$	Thermal Resistance, Junction-to-Ambient		41	°C/W



Table 3. Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States	•					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =-250µA	-30			V
		V _{DS} =-30V, V _{GS} =0V T _J =25°C			-1	μΑ
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-30V, V _{GS} =0V T _J =125°C			-100	μΑ
lgss	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-1		-2.5	V
g FS	Forward Transconductance	V _{DS} =-5V, I _D =-10A		15		S
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =-10V, I _D =-10A T _J =25°C		17	21.3	mΩ
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =-4.5V, I _D =-5A T _J =25°C		22.9	30.5	mΩ
Dynamic Chara	octeristics	,		•		
Ciss	Input Capacitance			1160		pF
Coss	Output Capacitance	V _{DS} =-15V,V _{GS} =0V, f=1.0MHz		138		pF
Crss	Reverse Transfer Capacitance			119		pF
Rg	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1.0MHz		5.4		Ω
Switching Para	meters					
t _{d(on)}	Turn-on Delay Time			7		nS
t _r	Turn-on Rise Time	V _{GS} =-10V, V _{DS} =-15V,		6		nS
t _{d(off)}	Turn-Off Delay Time	R _L =1 Ω , R _{GEN} =3 Ω		112		nS
t _f	Turn-Off Fall Time			78		nS
Qg	Total Gate Charge			59		nC
Qgs	Gate-Source Charge	V _{GS} =-10V, V _{DS} =-15V, I _D =-15A		10		nC
Q_gd	Gate-Drain Charge			14		nC
Source-Drain D	Piode Characteristics			-		
I _{SD}	Source-Drain Current (Body Diode)				-9.5	А
V _{SD}	Forward on Voltage (Note 3)	V _{GS} =0V, I _S =-15A			-1.2	V
t _{rr}	Reverse Recovery Time	I _F =-15A, dI/dt=100A/μs		21		ns
Qrr	Reverse Recovery Charge	I _F =-15A, dI/dt=100A/μs		10		nC

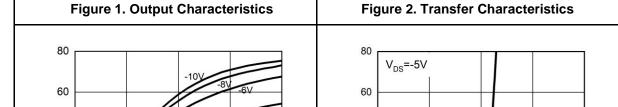
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

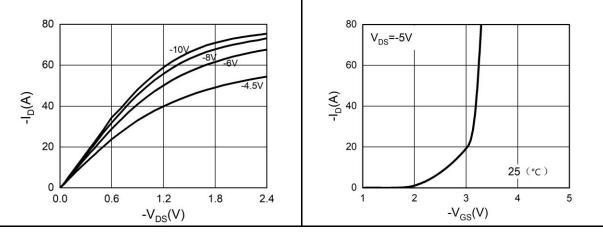
Notes 2.E_{AS} condition: $T_J=25^{\circ}C$, $V_{DD}=-30V$, $V_{G}=-10V$, $Rg=25\Omega$, L=0.5mH.

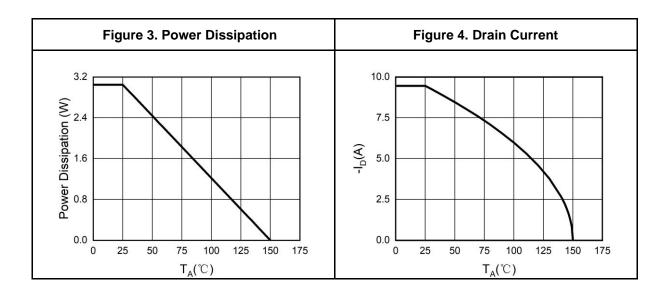
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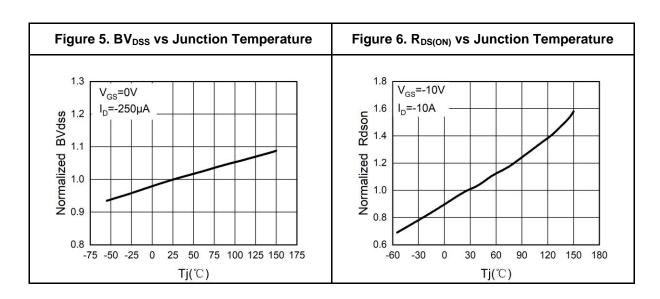


Typical Electrical And Thermal Characteristics (Curves)



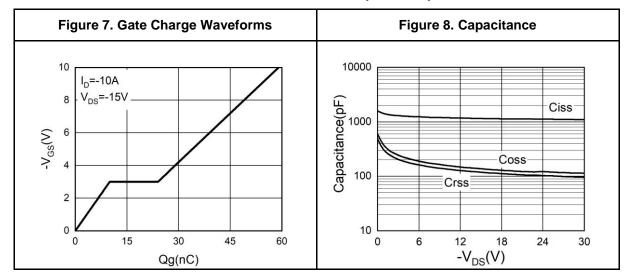


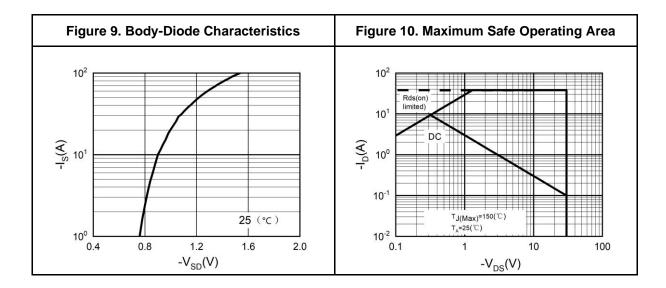






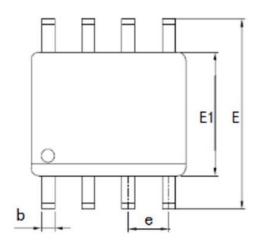
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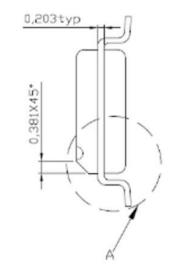


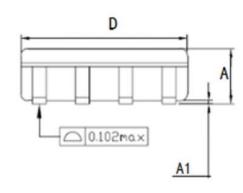


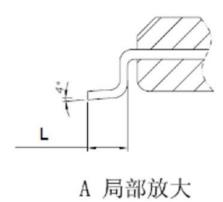


SOP-8 Package Information









	Dime			
Symbol	Min.	Nom.	Max	
А	1.35	1.55	1.75	
A1	0.1	0.15	0.2	
b	0.346	0.406	0.466	
D	4.8	4.89	4.98	
E	5.75	6.00	6.25	
E1	3.81	3.90	3.99	
е	1.27TYP			
L	0.406	0.838	1.27	



Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

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